

### 26NM65SZ-U3

Preliminary

# 26A, 650V N-CHANNEL SUPER-JUNCTION MOSFET

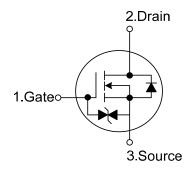
#### DESCRIPTION

The **UTC 26NM65SZ-U3** is a Super Junction MOSFET Structure and is designed to have better characteristics, such as fast switching time, low gate charge, low on-state resistance and a high rugged avalanche characteristics. This power MOSFET is usually used at AC-DC converters for power applications.

#### FEATURES

- \*  $R_{DS(ON)} \le 0.155 \ \Omega \ @V_{GS}=10V, I_D=13A$
- \* Fast switching capability
- \* Avalanche energy tested
- \* Improved dv/dt capability, high ruggedness
- \* With ESD Protected: HBM=2KV

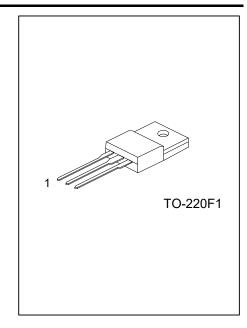
#### SYMBOL



#### ORDERING INFORMATION

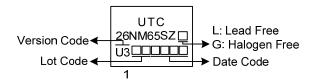
Ordering Number			Daakaga	Pin Assignment			Deaking	
Lead Free		Halogen Free	Package	1	2	3	Packing	
26NM65SZL-U3-TF	1-T	26NM65SZG-U3-TF1-T	TO-220F1	G	D	S	Tube	
Note: Pin Assignment: G: Gate D: Drain S: Source								
26NM65SZG-U3-TF1-T								
		—— (1)Packing Type	(1) T: Tube					
		—— (2)Package Type	(2) TF1: TO-220F1					
		(3)Version Code	(3) Version U3	3				

- (4)Green Package (4) G: Halogen Free and Lead Free, L: Lead Free



# 26NM65SZ-U3

#### MARKING





#### Preliminary

#### ■ ABSOLUTE MAXIMUM RATINGS (Tc=25°C, unless otherwise specified)

PARAMETER			SYMBOL	RATINGS	UNIT
Drain-Source Voltage			V <sub>DSS</sub>	650	V
Gate-Source Voltage			V <sub>GSS</sub>	±20	V
Drain Current	Continuous	T <sub>C</sub> =25°C	ID	26	А
	Pulsed (Note 2)		I <sub>DM</sub>	78	А
Avalanche Energy	Single Pulsed (I	Single Pulsed (Note 3)		62.5	mJ
Peak Diode Recovery	de Recovery dv/dt (Note 4)			4.4	V/ns
Power Dissipation			PD	33	W
Junction Temperature			TJ	+150	°C
Storage Temperature			T <sub>STG</sub>	-55 ~ +150	°C

Notes: 1. Absolute maximum ratings are those values beyond which the device could be permanently damaged. Absolute maximum ratings are stress ratings only and functional device operation is not implied.

2. Repetitive Rating: Pulse width limited by maximum junction temperature.

3. L = 10mH,  $I_{AS}$  = 3.5A,  $V_{DD}$  = 50V,  $R_G$  = 25 $\Omega$  Starting  $T_J$  = 25°C

4. I\_{SD}  $\leq$  26A, di/dt  $\leq$  200A/µs, V\_{DD}  $\leq$  BV<sub>DSS</sub>, Starting T<sub>J</sub> = 25°C

#### THERMAL DATA

PARAMETER	SYMBOL	RATINGS	UNIT
Junction to Ambient	θ <sub>JA</sub>	62.5	°C/W
Junction to Case	θις	3.79	°C/W

Note: Device mounted on FR-4 substrate PC board, 2oz copper, with 1inch square copper plate.



### Preliminary

**Power MOSFET** 

#### ■ ELECTRICAL CHARACTERISTICS (TJ=25°C, unless otherwise specified)

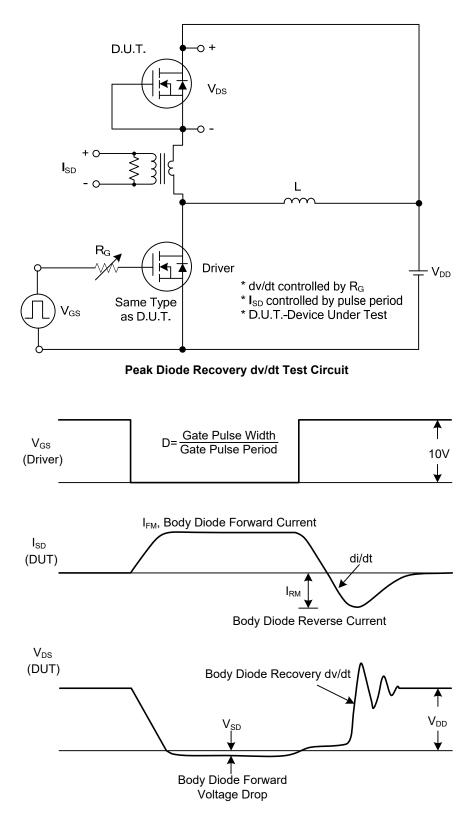
BYMBOL BV <sub>DSS</sub>		MIN	TYP	MAX	UNIT
	V <sub>GS</sub> =0V, I <sub>D</sub> =250µA	650			V
IDSS	V <sub>DS</sub> =650V, V <sub>GS</sub> =0V			1	μA
I <sub>GSS</sub>	V <sub>GS</sub> =±20V, V <sub>DS</sub> =0V			±10	μA
V <sub>GS(TH)</sub>	V <sub>DS</sub> =V <sub>GS</sub> , I <sub>D</sub> =250µA	2.5		4.5	V
R <sub>DS(ON)</sub>	V <sub>GS</sub> =10V, I <sub>D</sub> =13A			0.155	Ω
CISS			1283		рF
Coss	V <sub>GS</sub> =0V, V <sub>DS</sub> =50V, f=1MHz		377		рF
C <sub>RSS</sub>			2		pF
$Q_{G}$			32		nC
Q <sub>GS</sub>			10		nC
Q <sub>DD</sub>			7		nC
t <sub>D(ON)</sub>			22		ns
t <sub>R</sub>	V <sub>DD</sub> =100V, V <sub>GS</sub> =10V, I <sub>D</sub> =3A,		21		ns
t <sub>D(OFF)</sub>	R <sub>G</sub> =25Ω (Note 1, 2)		94		ns
t⊧			32		ns
ARACTERI	STICS		_		
Continuous Drain-Source Diode				20	^
Is				20	A
la.				78	А
ISM				10	A
Von	$l_{c}=264$ $V_{cc}=0V$			1 /	V
VSD				1.4	v
t			108		nS
чт			400		110
Qrr			6274		nC
	V <sub>GS(TH)</sub> R <sub>DS(ON)</sub> C <sub>ISS</sub> C <sub>OSS</sub> C <sub>RSS</sub> Q <sub>G</sub> Q <sub>G</sub> Q <sub>DD</sub> t <sub>D(ON)</sub> t <sub>R</sub> t <sub>D(OFF)</sub> t <sub>F</sub> <b>NRACTERI</b> I <sub>S</sub> I <sub>SM</sub> V <sub>SD</sub> t <sub>rr</sub>	$\begin{array}{c c c c c c } & V_{GS} = \pm 20 V, V_{DS} = 0 V \\ \hline V_{GS(TH)} & V_{DS} = V_{GS}, I_D = 250 \mu A \\ \hline R_{DS(ON)} & V_{GS} = 10 V, I_D = 13 A \\ \hline \\ \hline \\ \hline \\ \hline \\ C_{ISS} & \\ \hline \\$	$\begin{array}{c c c c c c c } I_{GSS} & V_{GS} = \pm 20V, V_{DS} = 0V & & & & \\ \hline V_{GS(TH)} & V_{DS} = V_{GS}, I_D = 250 \mu A & 2.5 \\ \hline R_{DS(ON)} & V_{GS} = 10V, I_D = 13A & & & \\ \hline \hline C_{ISS} & & & & \\ \hline C_{OSS} & V_{GS} = 0V, V_{DS} = 50V, f = 1 M Hz & & \\ \hline C_{RSS} & & & & \\ \hline \\ \hline$	$\begin{array}{c c c c c c c c c c c c c c c c c c c $	$\begin{array}{c c c c c c c c c c c c c c c c c c c $

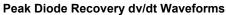
Notes: 1. Pulse Test: Pulse width  $\leq$  300µs, Duty cycle  $\leq$  2%.

2. Essentially independent of operating temperature.



#### TEST CIRCUITS AND WAVEFORMS



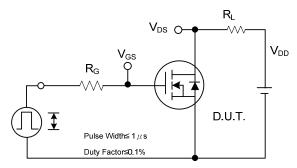




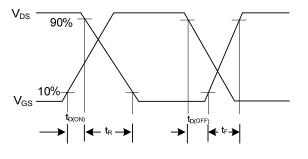
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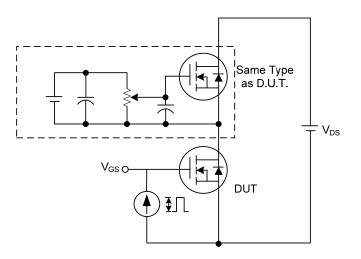
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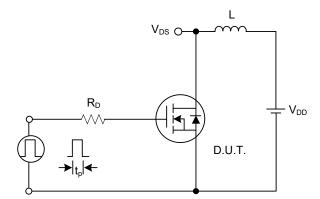
Switching Test Circuit



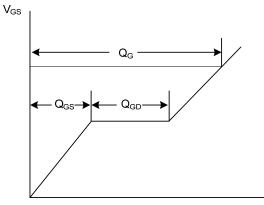
Switching Waveforms



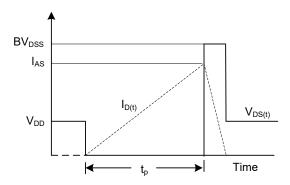
Gate Charge Test Circuit



Unclamped Inductive Switching Test Circuit



Charge Gate Charge Waveform



Unclamped Inductive Switching Waveforms



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